

500V Super-Junction Power MOSFET

FEATURES

- Very low FOM $R_{DS(on)} \times Q_g$
- 100% avalanche tested
- RoHS compliant

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)

то-220 др 5	TO-220F GDS	TO-251 G D S
RoHS	TO-252	a o transformed and a second sec

Device Marking and Package Information				
Device	TPA50R5K4C	TPP50R5K4C	TPU50R5K4C	TPD50R5K4C
Package	TO-220F	TO-220	TO-251	TO-252
Marking	50R5K4C	50R5K4C	50R5K4C	50R5K4C

Absolute Maximum Ratings $T_c = 25^{\circ}C$, unless otherwise noted

Absolute maximum Natings $T_{\rm C} = 23$ C, unless otherwise noted					
	Sympol	Value		11	
	Symbol	TO-220, TO-251, TO-252	TO-220F	Unit	
Drain-Source Voltage (V _{GS} = 0V)		500		V	
	I _D	1		А	
(note1)	I _{DM}	3		А	
	V_{GSS}	±30		V	
(note2)	E _{AS}	0.45		mJ	
(note1)	I _{AR}	0.3		А	
(note1)	E _{AR}	0.01		mJ	
Power Dissipation ($T_c = 25^{\circ}C$)		5.4	2.7	W	
Operating Junction and Storage Temperature Range		-55~+150		°C	
	(note1) (note2) (note1)	Symbol V _{DSS} I _D (note1) V _{GSS} (note2) E _{AS} (note1)	Symbol Value V_{DSS} TO-220, TO-251, TO-252 V_{DSS} 500 I_D 1 (note1) I_{DM} 3 V_{GSS} ±30 (note2) E_{AS} 0.45 (note1) I_{AR} 0.3 (note1) E_{AR} 0.01 P_D 5.4	Symbol Value TO-220, TO-251, TO-252 TO-220F V_{DSS} 500 I_D 1 (note1) I_{DM} 3 V_{GSS} ±30 (note2) E_{AS} 0.45 (note1) I_{AR} 0.3 (note1) E_{AR} 0.01 P_D 5.4 2.7	

Thermal Resistance					
Peremeter	Symbol	Value		11	
Parameter	Symbol	TO-220, TO-251, TO-252	TO-220F	Unit	
Thermal Resistance, Junction-to-Case	R_{thJC}	23	46		
Thermal Resistance, Junction-to-Ambient	R _{thJA}	62	80	K/W	

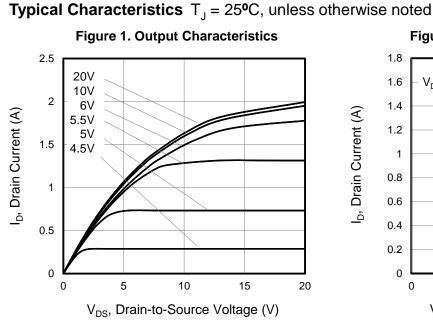


Specifications T _J = 25°C, ur	less othe	rwise noted					
Perometer	Symbol Tost Conditions	Value			11		
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0V, I_{D} = 250 \mu A$	500			V	
Zara Cata Valtaga Drain Current		$V_{DS} = 500V, V_{GS} = 0V, T_{J} = 25^{\circ}C$			1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 500V, V _{GS} = 0V, T _J = 150°C			100	μA	
Gate-Source Leakage	I _{GSS}	V_{GS} = $\pm 30V$			±100	nA	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2.5		4.0	V	
Drain-Source On-Resistance (Note3)	$R_{DS(on)}$	V _{GS} = 10V, I _D = 0.3A		4.9	5.4	Ω	
Forward Transconductance (Note3)	g _{fs}	V _{DS} = 10V, I _D = 0.3A		0.5		S	
Dynamic				•			
Input Capacitance	C _{iss}	$\gamma = 0 \gamma$		53			
Output Capacitance	C _{oss}	$V_{GS} = 0V,$ $V_{DS} = 50V,$		21		pF	
Reverse Transfer Capacitance	C _{rss}	f = 1.0MHz		4			
Total Gate Charge	Q _g			1.5		nC	
Gate-Source Charge	Q _{gs}	$V_{DD} = 400V, I_D = 1A, V_{GS} = 10V$		0.3			
Gate-Drain Charge	Q_{gd}	65		0.6			
Turn-on Delay Time	t _{d(on)}			16			
Turn-on Rise Time	t _r	V _{DD} = 400V, I _D = 1 A,		30		1	
Turn-off Delay Time	t _{d(off)}	$R_{G} = 25\Omega$		20		ns	
Turn-off Fall Time	t _f			35			
Drain-Source Body Diode Characteri	stics						
Continuous Body Diode Current	I _S	T 0500			1	٨	
Pulsed Diode Forward Current	I _{SM}	T _C = 25°C			3	A	
Body Diode Voltage	V _{SD}	T _J = 25°C, I _{SD} = 1A, V _{GS} = 0V		0.9	1.2	V	
Reverse Recovery Time	t _{rr}			35		ns	
Reverse Recovery Charge	Q _{rr}	$V_R = 400V, I_F = I_S,$ $di_F/dt = 100A/\mu s$		0.1		μC	
Peak Reverse Recovery Current	l _{rrm}	THE COULD		1.4		А	

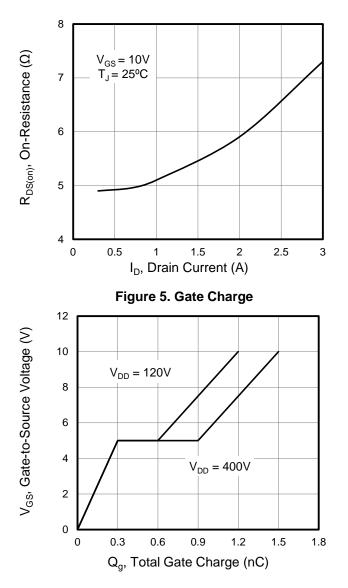
Notes

- 1. Repetitive Rating: Pulse Width limited by maximum junction temperature
- 2. I_{AS} = 0.3A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25°C
- 3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 1%









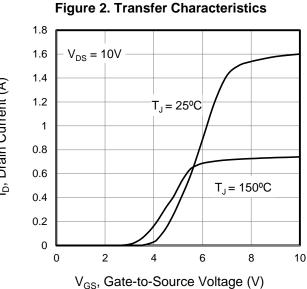


Figure 4. Capacitance

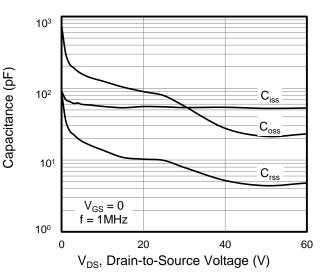
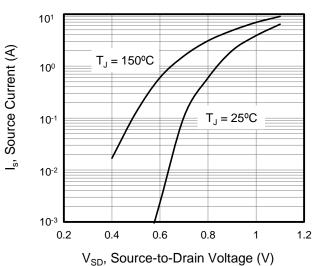
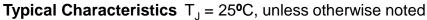


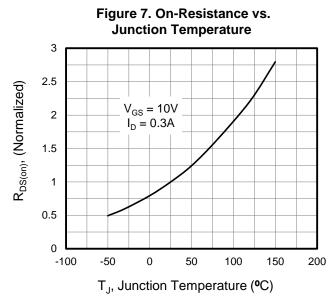
Figure 6. Body Diode Forward Voltage

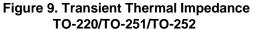


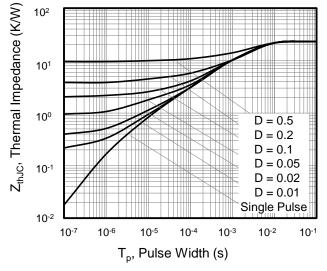
TPA50R5K4C, TPP50R5K4C, TPU50R5K4C, TPD50R5K4C

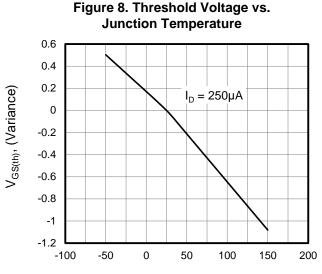






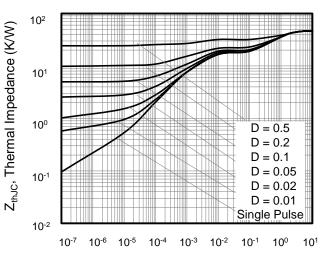






T_J, Junction Temperature (^oC)

Figure 10. Transient Thermal Impedance TO-220F







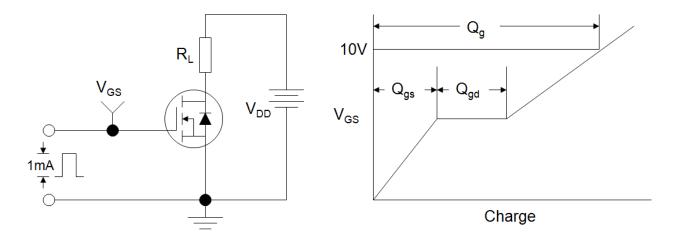


Figure B: Resistive Switching Test Circuit and Waveform

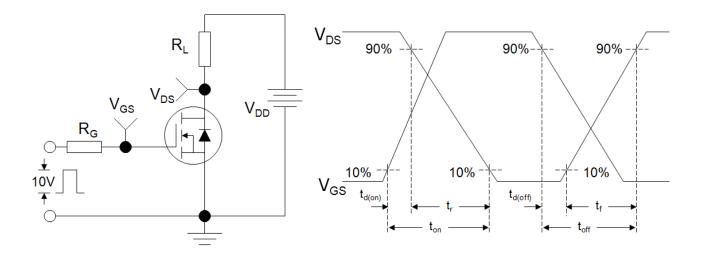
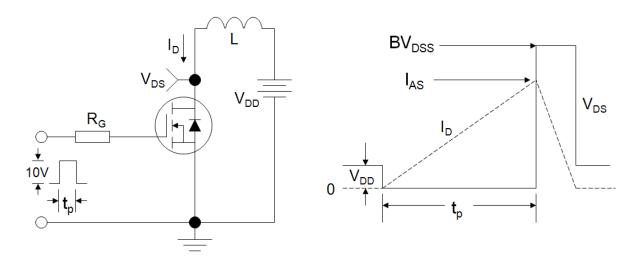
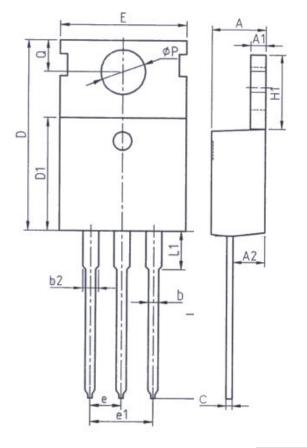
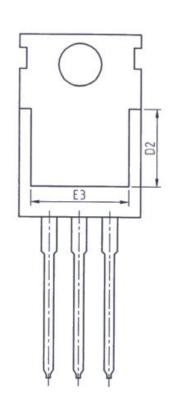


Figure C: Unclamped Inductive Switching Test Circuit and Waveform



TO-220

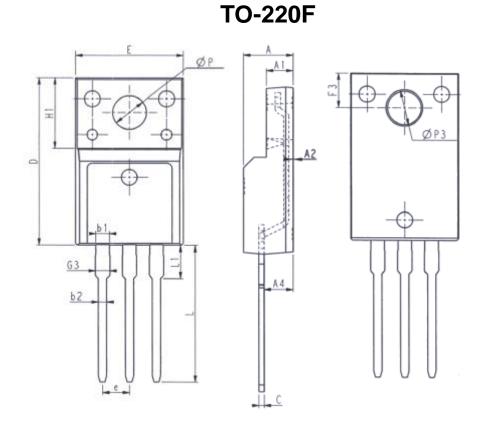




Unit: mm				
Symbol	Min.	Max.		
Α	4.37	4.77		
A1	1.25	1.45		
A2	2.20	2.60		
b	0.70	0.95		
b2	1.17	1.47		
С	0.40	0.65		
D	15. 10	16. 10		
D1	8.80	9.40		
D2	5.50	-		

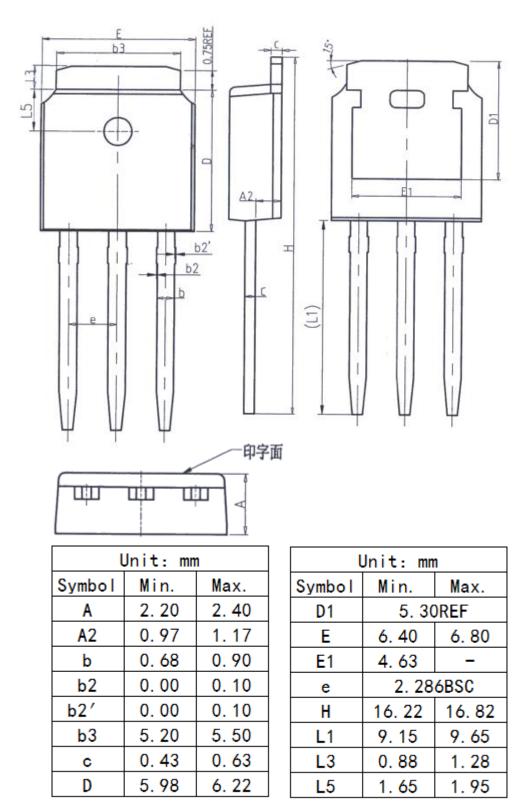
Unit: mm				
Symbol	Min. Max.			
E	9.70	10.30		
E3	7.00	-		
e	2. 54BSC			
e1	5. 08	BBSC		
H1	6.25	6.85		
L	12.75	13.80		
L1	- 3.40			
Р	3. 40	3.80		
Q	2.60	3.00		





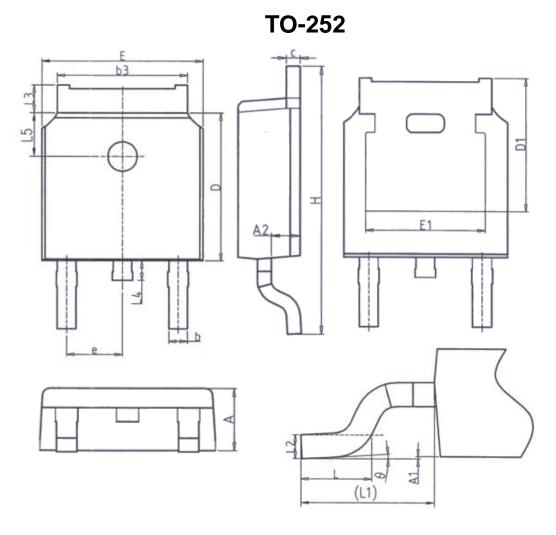
Unit: mm			Unit: mm		
Symbol	Min.	Max.	Symbol	Min.	Max.
E	9.96	10.36	L	12.68	13. 28
Α	4.50	4.90	L1	2.93	3.13
A1	2.34	2.74	Р	3.03	3. 38
A2	0.30	0.60	P3	3.15	3.65
A4	2.56	2.96	F3	3.15	3.45
с	0.40	0.65	G3	1.25	1.55
D	15. 57	16. 17	b1	1.18	1.43
H1	6. 70REF		b2	0.70	0.95
е	2. 54BSC				





TO-251





Unit: mm				
Symbol	Min.	Max.		
A	2.20	2.40		
A1	0.00	0.20		
A2	0.97	1.17		
b	0.68	0.90		
b3	5.20	5.50		
с	0.43	0.63		
D	5.98	6. 22		
D1	5. 30REF			
E	6.40	6.80		
E1	4.63	-		

Unit: mm			
Symbol	Min. Max.		
е	2. 28	6BSC	
Н	9.40	10.50	
L	1.38	1.75	
L1	2. 90REF		
L2	0, 51	BSC	
L3	0.88	1.28	
L4	- 1.00		
L5	1.65 1.95		
θ	0°	8°	



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